SPECIFICATION FOR APPROVAL 承 认 书

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Description

Vender's Part No.

Customer's. Part No.

Serial No.

Version No.

Magne	tic Bu	Izzer

SND-2310

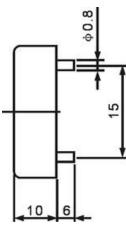
1.1

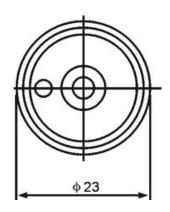
CUSTOMER'S APPROVED SIGNATURE			

Approved By	Checked By	Made By
		曹小丽

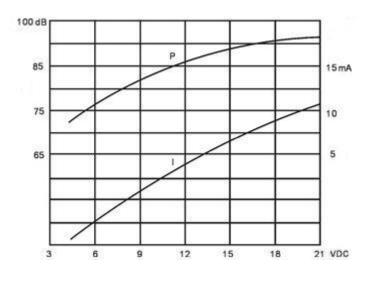
B. SPECIFICATION				
No.	ltem	Unit	Specification	Condition
1	Oscillation Frequency	Hz	3500±500	Vo-p=1/2duty , square wave
2	Operating Voltage	Vo-p	3~24	
3	Rated Voltage	Vo-p	12	
4	Current Consumption	mA	≤10	at Rated Voltage
5	Sound Pressure Level	dB	MIN. 85	at 10cm at Rated Voltage
6	Operating Temperature	°C	-20 ~ +60	
7	Storage Temperature	°C	-30 ~ +70	
8	Dimension	mm	Ф23 x H10	See appearance drawing
9	Weight (MAX)	gram	4.0	
10	Housing Material		ABS(Black)	

C. APPEARANCE DRAWING Tol: ±0.5 Unit: mm





D:FREQUENCY RESPONSE 频率



E. RELIABILITY TEST

Item		Test condition	Criteria	引用规格
1	High temperature Preservation	Exposure to +85°C for 96 hrs.	After the test the part shall meet specificati	GB/T 2423.2
2	Low temperature preservation	Exposure to -40°C for 96 hrs.	-ons without any degra -dation in appearance And performance except	GB/T 2423.1
3	Thermal Shock	-40°C +85°C 30min 30min 10 cycles	SPL.	GB/T 2423.4
4	Thermal,Humidity Shock	65℃、90~95%RH 25℃、90~95%RH 3. b=0.5H 3. b=0.5H 12H.(1 个周期) 10 cycles		
5	Ordinary Temp.Life	Driving the sounder at 5VDC for 1000hrs in the room temperature(25°C±10°C)		
6	High Temp.Life	Driving the sounder at 6.5VDC for 500hrs in the low temperature(+85°C)		
7	Low Temp.Life	Driving the sounder at 5VDC for 500hrs in the low temperature(-40°C)		
8	Lead strength	Pull load on the direction of the terminal axis for 10±1 sec.		GB/T 2423.29
9	Vibration	10~55~10Hz Sinewave,Sweep 1 min,Amplitude 1.52mm Max91m/S ² X,Y,Z 3Direction 2hrs each,Total 6hrs		GB/T 2423.10
10	Free drop	Free drop,70cm height, on wood boad (t40mm) X,Y,Z 3Direction 1time each, total 3times.	Exclude bending of Pin	GB/T 2423.8
11	Solder heat resistance	Soldering into solderbath:Solder Temp.350±10°C Soaking Time: 3.5±0.5sec	After the test the part Shall meet specificatio	GB/T 2423.28
12	Washability	Solvent:deionized water, Solvent temp:55±5°C Soaking time:5±0.5minutes	-ns without any degrada -tion in appearance and performance	
13	Solderability	Pretreatment:40°C,90~95%RH*240hrs Soldering into solderbath:Solder Temp.360±5°C Soaking Time: 2±0.5sec	95% surface of lead pins must be covered with fresh solder and no soldering holes Should be found	GB/T 2423.28